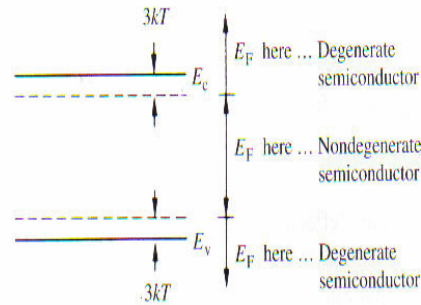


**ECSE-2210 Microelectronics Technology**  
**Class Activity 5 – Solution**

Assume  $T = 300$  K for all your calculations. Assume  $n_i = 10^{10} \text{ cm}^{-3}$  at 300 K for Si.

- 1) Explain what “degenerate” and “non-degenerate” semiconductors mean. Non-degenerate means that the Fermi level lies in the band gap such that  $E_C - 3kT > E_F > E_V + 3kT$



**Figure 2.19** Definition of degenerate/nondegenerate semiconductors.

When  $E_F$  lies in the band gap closer than  $3kT$  to either band edge or actually lies in the band, the semiconductor is said to be degenerate. Degenerate indicates that the semiconductor is very heavily doped.

- 2) Calculate the numerical value of the following integral (assume Si contains  $10^{15} \text{ cm}^{-3}$  electrons in its conduction band). It should not take more than 30 seconds to answer this.

$$\int_{E_{C, \text{bottom}}}^{E_{C, \text{top}}} g_c(E) f(E) dE$$

What will be the number of holes/cm<sup>3</sup> in Si?

The integral represents the total number of electrons in the conduction band, i.e.,  $10^{15} \text{ cm}^{-3}$ .

The number of holes is  $p = 10^5 \text{ cm}^{-3}$ . [ $np = n_i^2$  so,  $p = n_i^2/n = 10^5 \text{ cm}^{-3}$ .]

- 3) For a silicon sample maintained at  $T = 300\text{K}$ , the number of electrons in the conduction band, (i.e.,  $n$ ) is  $1 \times 10^{16} \text{ cm}^{-3}$ . Calculate the number of holes in the valence band (i.e.,  $p$ ). Also, draw the band diagram (i.e., mark the position of the Fermi-level,  $E_F$ , and  $E_C$ ,  $E_V$ , and  $E_i$ ).

The number of holes is  $np = n_i^2$  so,  $p = n_i^2/n = (10^{20}/10^{16}) \text{ cm}^{-3} = 10^4 \text{ cm}^{-3}$ .  
 $E_F - E_i = kT \ln(10^{16}/10^{10})$ . This means that  $E_F$  is 0.353 eV above  $E_i$

4) For a semiconductor (not Si) with a band gap 1 eV, the  $n$  and  $p$  values are  $1 \times 10^{16} \text{ cm}^{-3}$  and  $1 \times 10^6 \text{ cm}^{-3}$ , respectively. Is the semiconductor n-type or p-type? What will be the intrinsic carrier concentration for this semiconductor?  
 N-type since  $n > p$ .  $n_i = (np)^{1/2} = 10^{11} \text{ cm}^{-3}$ .

5) A Si wafer is uniformly doped with  $2 \times 10^{17} \text{ cm}^{-3}$  of Phosphorous and  $4 \times 10^{17} \text{ cm}^{-3}$  of Boron. Assuming full ionization, calculate the following quantities at room temperature ( $T = 300 \text{ K}$ ).

(a) The equilibrium hole concentration,  $p$ . (start with the charge-neutrality condition).

$$p = N_A - N_D = 2 \times 10^{17} \text{ cm}^{-3}$$

(Use the full charge balance equation:  $p + N_D = n + N_A$ .)

Note that the phosphorous concentration is  $N_D$  and the boron concentration is  $N_A$

(b) The equilibrium electron concentration,  $n$ .

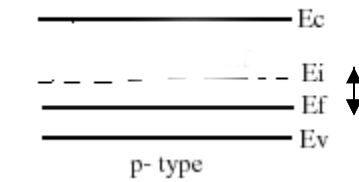
$$n = n_i^2/p = 10^{20}/(2 \times 10^{17}) \text{ cm}^{-3} = 500 \text{ cm}^{-3}$$

(c) The position of the Fermi level ( $E_F$ ) relative to the intrinsic level ( $E_i$ ). Draw the band diagram show these levels.

$$p = n_i \times \exp [(E_i - E_F) / kT]$$

$$2 \times 10^{17} = 10^{10} * \exp [(E_i - E_F) / kT]$$

$$(E_i - E_F) = 0.435 \text{ eV}$$



(d) Which one of the above three quantities ( $p$ ,  $n$ ) has the strongest temperature dependence near 300 K? Explain.

$n$  since it is  $n_i^2/p$ .  $p$  does not vary, but  $n_i$  increases exponentially with increasing  $T$ .

(e) Suppose you now add  $1 \times 10^{13} \text{ cm}^{-3}$  of Arsenic to the Si sample. What will be the equilibrium concentration of holes ( $p$ ) at 300 K? (Don't have to go through the whole math again. Make an educated guess with justification).

No change since  $10^{13} \text{ cm}^{-3}$  is small compared to  $2 \times 10^{17} \text{ cm}^{-3}$  of Phosphorous. Since the order of Arsenic that is added is 4 orders of magnitude less than that of phosphorous there is no significant change in the equilibrium concentration of holes.